

OPTO-ELECTRONIC DEVICES DIVISION ELECTRONIC COMPONENTS GROUP SHARP CORPORATION

SPECIFICATION

DEVICE SPECIFICATION FOR

Infrared Detecting unit for Remote Control

MODEL No.

GP1UV70QS series

Specified for

Enclosed please find copies of the Specifications which consists of 12 pages including cover. After confirmation of the contents, please be sure to send back copies of the Specifications with approving signature on each.

CUSTOMER'S APPROVAL

PRESENTED

DATE

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H. Ogura, Department General Manager of Engineering Dept., III Opto-Electronic Devices Div. ELECOM Group SHARP CORPORATION

DATE

BY

REFERENCE Infrared Detecting unit for Remote Control Product name :

GP1UV70OS series

December 27, 2002

ED-02244A

Model No.: GP1UV70OS series

1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.

2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

(1) This product is designed for use in the following application areas;

• OA equipment • Audio visual equipment Home appliances

• Telecommunication equipment (Terminal)

If the use of the product in the above application areas is for equipment listed in paragraphs (2) or (3), please be sure to observe the precautions given in those respective paragraphs.

(2) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as ;

• Transportation control and safety equipment (aircraft, train, automobile etc.)

- Traffic signals Gas leakage sensor breakers Rescue and security equipment
- Other safety equipment etc.
- (3) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;

Space equipment Telecommunication equipment (for trunk lines)

Nuclear power control equipment · Medical equipment etc.

(4) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above three paragraphs.

3. Please contact and consult with a Sharp sales representative for any questions about this product.

1. Application

This specifications applies to the model marked "O" in the following models of infrared detecting unit for

The model list of GP1UV70QS series

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GP1UV70OS series

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| Application | Model No. | B.P.F. center frequency (TYP) | | |
|-------------|------------|-------------------------------|--|--|
| | GP1UV70QS | 40 kHz | | |
| | GP1UV700QS | 36 kHz | | |
| | GP1UV701QS | 38 kHz | | |
| | GP1UV702QS | 36.7 kHz | | |

Main application : TV set, VCR, Radio cassette recorder, Stereo

Outline Refer to the attached sheet, Page 8.

- 3. Ratings and characteristics Refer to the attached sheet, Page 4 to 7.
- 4. Reliability Refer to the attached sheet, Page 9.
- 5. Outgoing inspection Refer to the attached sheet, Page 10.

6. Supplement

- 1) This infrared detecting unit for remote control satisfies each performance requirements in para. 3.5, in the standard optical system in Fig.2.
- 2) This product is built-in photodiode.
- 3) Product mass: Approx. 0.7g
- 4) This product shall not contain the following materials.
 Also, the following materials shall not be used in the production process for this product.
 Materials for ODS : CFC_s, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

Brominated flame retardants
 Specific brominated flame retardants such as the PBBO_S and PBB_S are not used in this device at all.

- 6) Packing specification : Refer to the attached sheet, Page 11.
- 7) Country of origin : Philippine, Indonesia

7. Notes

1) Transmitting code

When this infrared remote control detecting unit shall be adopted for wireless remote control, please use it with the signal format of transmitter, which total duty ratio Dt (Emitting time $\sum_{N=1}^{n} t_N$ /Transmitting time for 1 block T) is 40% or less. ON signal time T_{ON} (Pulse width of the presence of modulated IR) should be 250 μ s or more. In case that the signal format of total duty and ON signal time is out of above conditions, there is a case that reception distance is much reduced or output is not appeared.



2) Transmitter

Please use a light emitting unit (remote control transmitter) taking into consideration such factors as the performances, characteristics and operating condition of the light emitting element and the characteristics of this light detecting unit.

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3) Detector face and cleaning

If the surface of detector is smeared with dust or dirt, it may cause faulty operation. Caution shall be taken to avoid this. And do not touch the detector surface. If the surface was smeared, wipe it clean with soft cloth. If any solvent is needed, Methyl alcohol, Ethyl alcohol, or Isopropyl alcohol should be used.

Please don't carry out washing. Because, after washing the remainder in solvent or flux in this device cause malfunction. Marking on this device is defaced by washing.

- 4) Mounting this product
 - · The shield case shall be grounded on the PCB pattern.
 - (There are two cases that shield case and GND pin are connected in the shield case, or are not connected in it.)
 - It shall not be applied the terminal and case with unnecessary stress.
 - · Please don't push the detecting side (photodiode) from external.
 - · In order to prevent electrostatic discharge of integrated circuit, human body and soldering iron, etc. shall be grounded.
 - The holes and the slits on the infrared detecting unit shall not be used as the other purpose to maintain its performance.
 - · When mounting, please mount the external circuit below. (CR filter)

(External parts should be mounted as close as possible to the sensor.)



The circuit constant is a example. It is difference from mounting equipment. Please select it by your mounting equipment. This device has a transistor as protection element between Vcc and GND to improve anti-static electricity proof.

Please be carefully not to apply exceeding the absolute maximum ratings of applying voltage and continuous high voltage spike noise because there is cases that transistor will be short by secondary breakdown generally.

In order to do difficultly, Please add CR filter (47 Ω (1/10W), 10 μ F or more) such as external circuit example above near Vcc. 5) Characteristics of this product

• There is a possibility that noise on output may be caused by environmental condition etc. even if there is no input transmission signal.

• Please shall confirm operation or your actual machine. Because the output pulse width of this product is fluctuated by environmental conditions such as signal format, temperature, distance from transmitter, and so on.

6) Soldering

. In case that this product is kept in high humidity condition, it may be hard to solder, please be careful enough

about storage method. Depend on the flux you select, there are different solderabilities, so please select a suitable flux and use it.

- · Please don't do soldering this product by reflow.
- Please make sure in case of hand soldering that you use the solder iron with less than 45W power and the solder iron point (edge) temperature is less than 320°C within 3 seconds, and also don't add any force to lead frame directly.

• Please make sure also you check the mountability prior to the process since the solder portion between the case and the lead frame may be detached due to the heat when soldering.

7) Use condition

Please use this device away from the dew drop. Be aware that the dew drop rusts shield case and others, may affect the electric characteristics.

8) Output circuit

In case output of Vout (Voltage of Voh in the below chart) decreases due to influence from the external circuit, please adjust the circuit constants so that Voh is kept more than 2.8V.

Ex.) When adding transistors to output circuit, they shall be added as R1, R2 shown on the right chart & their value shall be adjusted so that Voh becomes 2.8V or more. (RL=about 100k Ω)



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9) Outlook of device

The lead flame may be deformed since the device is packed in vinyl bag.

3. Ratings and characteristics

3.1 Schematic



3.2 Absolute maximum ratings

| Parameter | Symbol | Ratings | Unit |
|-----------------------|--------|------------------------------|------|
| Supply voltage | Vcc | 0 to 6.0 | v |
| Operating temperature | Topr | -10 to +70 | °C |
| Storage temperature | Tstg | -20 to +70 | °C |
| Soldering temperature | Tsol | 260 (Soldering time : 5s) ※2 | °C |

※1) No dew drop

2) 1.6mm at mounting on single-sided PCB



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JV70OS series

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3.3 Recommended operating conditions

| Parameter | Symbol | Operating condition | Unit |
|----------------|--------|---------------------|------|
| Supply voltage | Vcc | 4.5 to 5.5 | V |

3.4 Electrical characteristics

(Unspecified Ta=25°C, Vcc=+5V)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Remark |
|---------------------------|-----------------|---------|------------|------|------|---------------------------|
| Current dissipation | Icc | - | 0.95 | 1.5 | mA | No input light |
| High level output voltage | V _{OH} | Vcc-0.5 | | - | V | *3 |
| Low level output voltage | V _{OL} | - | - | 0.45 | V | ₩3 I _{OL} =1.6mA |
| High level pulse width | T ₁ | 600 | | 1200 | μs | *3 |
| Low level pulse width | T ₂ | 400 | | 1000 | μs | ※ 3 |
| BPF. center frequency | f ₀ | | ※ 4 | | kHz | |
| Output pull-up resistance | RL | 70 | 100 | 130 | kΩ | |

3) The burst wave as shown in the figure on the right shall be transmitted by the transmitter shown in Fig.1.
However, the carrier frequency of transmitter is same as 34 kHz.
Measuring shall be from just after starting the transmission until 50 pulse.





| Model No. | B.P.F. center frequency (TYP) | | |
|------------|-------------------------------|-----|--|
| GP1UV70QS | 40 | kHz | |
| GP1UV700QS | 36 | kHz | |
| GP1UV701QS | 38 | kHz | |
| GP1UV702QS | 36.7 | kHz | |

3 BPF. center frequency: f_0 of each model is shown in the list below.

3.5 Performance

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The output signal of this infrared detecting unit shall satisfy the following requirements with the transmitter shown in Fig.1 used in the standard optical system in Fig.2.

- 3.5.1 Characteristics of linear reception distance The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at L=0.2 to 8.5m, (\times 5) Ev<10lx, $\phi=0^{\circ}$ in Fig.2.
- 3.5.2 Characteristics of sensitivity angle reception distance

The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at L=0.2 to 6.0m, (\times 5) Ev<10lx, $\phi \leq 30^{\circ}$ in Fig.2.

- 3.5.3 Characteristics of anti-outer peripheral light reception distance
 - The output signal shall satisfy the electrical characteristic requirements in para. 3.4 at L=0.2 to 4.0m, (\times 5, \times 6) Ev \leq 300lx, ϕ =0° in Fig.2.
 - 35) It refers to detector face illuminance.
 - 3. Outer peripheral light source : CIE standard light source A shall be used and placed at 45° from the perpendicular axis at the detector face center.



In the figure above, the transmitter shall be set as the output Vout (p-p) will be 40mV. Note that the PD49PI in this application is the one with short-circuit current Isc= $2.6 \,\mu$ A measured at Ev=100lx. (Ev is the illuminance by CIE standard light source A (tungsten lamp)).





| Stam Model No. GP1UV70Q GP1UV701Q GP1UV702Q GP1UV700Q Production | StampSWithoutQS1QS2QS0 | ED-02244A GP1UV70QS series December 27, 2002 * Stamp area : Model name © 1291 Week (1 to 6) Month (1 to 9, X,Y,Z) Year (2002: 2) The "-" mark inside \bigcirc shows |
|---|---|--|
| Lot No. I | Production place | production place. (*3) |
| | | * Carved seal |
| 1291 | Philippine Indonesia | S ————— Sharp mark |
| 1291 | muonesia | |
| | | 2.2 4 5.6 6 6 7 7 7 7 7 7 7 7 7 7 7 7 7 |
| Unspecified toler. Case thickness: Case material: Case finish: So Lead material: Lead finish: So Mold resin: Ep Product mass: *2: Exclude s *3: The "-" | 0.3TYP. Fe older plating (Sn, Pb) Fe (Ag plating) older dip (Sn, Ag, Cu). xxy resin Approx. 0.7g sagged solder mark above lot number on country is referred to portion indicates solder reen case and leads. vever, it never short wi | er indicate production place. to the production place list.) ring connection area Scale GP1UV70QS series |
| | s should be acceptable | |
| | | |

4. Reliability

The reliability of products shall satisfy items listed below.



| Test Items | Test Conditions | Failure Judgement Criteria | Samples (n) Defective(C) |
|---|---|----------------------------------|-----------------------------|
| Terminal strength (Tension) | Weight: 5N, 30s / each terminal | | n=11, C=0 |
| Terminal strength (Bending) | Weight: 2.5N $0^{\circ} -90^{\circ} -0^{\circ}$, 2 times / each terminal | | n=11, C=0 |
| Shock | Acceleration : 1000m/s ² , 6ms 3 directions / 3 times | | n=11, C=0 |
| Variable frequency vibration | Frequency range : 10 to 55Hz/ sweep 1min Overall amplitude : 1.5mm X, Y, Z/2h each | | n=11, C=0 |
| * High temp. and high humidity storage | Ta=40°C, 90%RH, t=240h | Performance test in para. 3.5 | n=22, C=0 |
| * High temp. storage | Ta=70°C, t=240h | should not be satisfied. | n=22, C=0 |
| * Low temp. storage | Ta=-20°C, t=240h | | n=22, C=0 |
| * Temperature cycling | 1 cycle -20°C to +70°C (30min) (30min) 20 cycles test | | n=22, C=0 |
| * Operation life (High temperature) | Ta=70°C, Vcc=5V, t=240h | | n=22, C=0 |
| Solder heat | MAX. 260°C, 5s (1.6mm at mounting on single-sided PCB) | | n=11, C=0 |

In the test *mark above, the sample to be tested shall be left at normal temperature and humidity for 2hours after it is taken out of the chamber. (No dew drop)

Unit PCB .6mm 1.6mm Solderable -

- 5. Outgoing inspection
 - (1) Inspection lot
 - Inspection shall be carried out per each delivery lot.
 - (2) Inspection method

A single sampling plan, normal inspection level II based on ISO 2859 shall be applied.

| Classification of De | Classification of Defects Inspection Items | | AQL (%) |
|----------------------|--|--|---------|
| 1 | | Electrical characteristic defect of V_{OH} , V_{OL} , T_1 and T_2 in para. 3.4. | |
| Major defect | 2 | Distance between signal terminal and shield case (0.2mm or more) (Except for GND terminal) | 0.4 |
| | 3 | It should have no remarkable stains and cracks that give any influence of electrical characteristic on light detecting face. | |
| | 1 | Deformation of shield case (Satisfying outline dimensions of item 2) | |
| Minor defect | 2 | Stamp, Carved seal (It should be possible to read stamp and carved seal of item 2. Stamp and carved seal should be indicated at fixed position.) | 1.5 |



